



60V +175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _C = +25°C
60V	7.3mΩ @ V _{GS} = 10V	95A
607	15mΩ @ V _{GS} = 4.5V	67A

Description and Applications

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

- Power-management functions
- DC-DC converters
- Backlighting

Site 1:



Site 2:

PowerDI5060-8/SWP (Type UX)



Top View

Bottom View

Features

- Rated to +175°C—Ideal for High Ambient Temperature
- 100% Unclamped Inductive Switch (UIS) Test in Production
- Low Rds(ON)—Minimizes Power Losses
- Low Q_q—Minimizes Switching Losses
- < 1.1mm Package Profile—Ideal for Thin Applications
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part. A listing can be found at

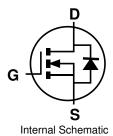
 $\underline{https://www.diodes.com/products/automotive/automotive-products/.}$

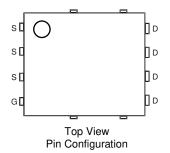
This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.

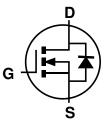
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Mechanical Data

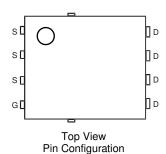
- Package: PowerDI[®]5060-8
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Terminals: Finish—Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.097 grams (Approximate)







Internal Schematic





Ordering Information (Note 4)

Part Number	Package	Packing		
rait Nullibei	rackaye	Qty.	Carrier	
DMNH6009SPS-13	PowerDI5060-8	2500	Tape & Reel	
DIVINHOU093F3-13	PowerDI5060-8/SWP (Type UX)	2500	Tape & Reel	

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information





☐ ☐ Hanufacturer's Marking

NH6009SS = Product Type Marking Code

YYWW = Date Code Marking

YY or YY = Year (ex: 23 = 2023)

WW = Week Code (01 to 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Drain-Source Voltage		VDSS	60	V
Gate-Source Voltage	V_{GSS}	±20	V	
Continuous Drain Current (Note 5) V _{GS} = 10V	$T_{C} = +25^{\circ}C$ $T_{C} = +100^{\circ}C$	I _D	95 67	А
Pulsed Drain Current (380µs Pulse, Duty Cycle = 1%)		Ірм	380	Α
Maximum Continuous Body Diode Forward Current (Note 5)		ls	95	Α
Pulsed Source Current (380μs Pulse, Duty Cycle = 1%)		I _{SM}	380	Α
Avalanche Current, L = 0.1mH (Note 6)		las	56	Α
Avalanche Energy, L = 0.1mH (Note 6)		Eas	226	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 7)		P _D	1.6	W
Thermal Resistance, Junction to Ambient (Note 7)	Steady State	Reja	95	°C/W
Total Power Dissipation (Note 8)		PD	3.3	W
Thermal Resistance, Junction to Ambient (Note 8)	Steady State	Reja	46	°C/W
Thermal Resistance, Junction to Case (Note 5)		R ₀ JC	1.5	C/VV
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	°C

Notes:

- 5. Thermal resistance from junction to soldering point (on the exposed drain pad).
- 6. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep $T_J = +25$ °C.
- 7. Device mounted on FR-4 PCB, with minimum recommended pad layout, single sided.
- 8. Device mounted on FR-4 substrate PCB, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.



Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

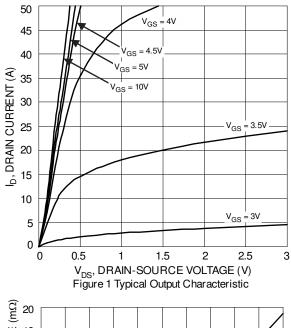
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)							
Drain-Source Breakdown Voltage	BV _{DSS}	60	_	_	V	V _G S = 0V, I _D = 1mA	
Zero Gate Voltage Drain Current, T _J = +25°C	IDSS	_	_	1	μΑ	V _{DS} = 48V, V _{GS} = 0V	
Gate-Source Leakage	Igss	_	1	±100	nA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	V _{GS(TH)}	1	2	3	٧	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	4.6	7.3	mΩ	$V_{GS} = 10V, I_D = 50A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	7.1	15	mΩ	$V_{GS} = 4.5V, I_D = 25A$	
Diode Forward Voltage	V _{SD}	_	0.7	1.2	V	VGS = 0V, IS = 1.7A	
DYNAMIC CHARACTERISTICS (Note 10)							
Input Capacitance	Ciss	_	1882	_	pF	V _{DS} = 30V, V _{GS} = 0V f = 1MHz	
Output Capacitance	Coss	_	374	_	рF		
Reverse Transfer Capacitance	Crss	_	111	_	pF		
Gate Resistance	Rg	_	2.1	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	18.5	_	nC		
Total Gate Charge (VGS = 10V)	Qg	_	37.3	_	nC	V _{DS} = 30V. I _D = 25A	
Gate-Source Charge	Qgs	_	5.0	_	nC	VDS = 30V, ID = 25A	
Gate-Drain Charge	Q_{gd}	_	11.2	_	nC		
Turn-On Delay Time	td(ON)	_	5.7	_	ns		
Turn-On Rise Time	tr	_	7.5	_	ns	$V_{GS} = 10V, V_{DS} = 30V$	
Turn-Off Delay Time	tD(OFF)	_	16.9	_	ns	$R_g = 3\Omega$, $I_D = 25A$	
Turn-Off Fall Time	t _F	_	6.3	_	ns		
Body Diode Reverse Recovery Time	trr	_	32	_	ns	I= 05A dl/dt 100A/vo	
Body Diode Reverse Recovery Charge	Qrr	_	30	_	nC	IF = 25A, dl/dt = 100A/µs	

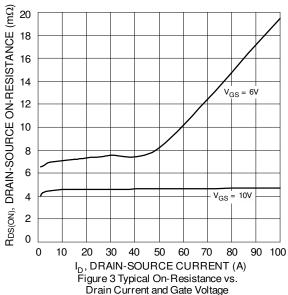
Notes:

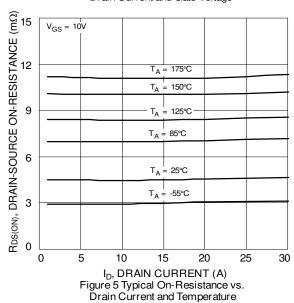
^{9.} Short duration pulse test used to minimize self-heating effect. 10. Guaranteed by design. Not subject to product testing.

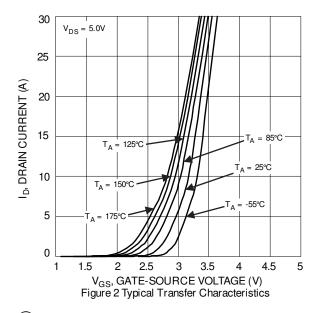


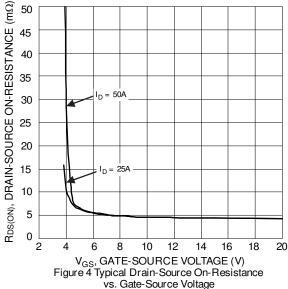












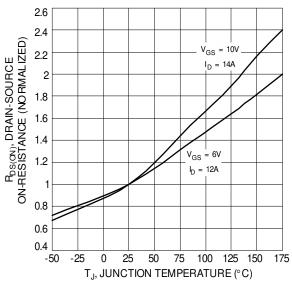
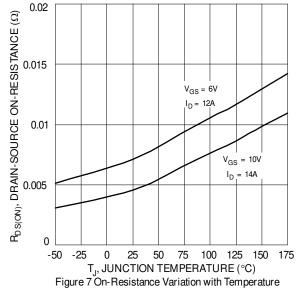
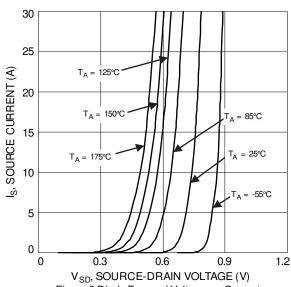


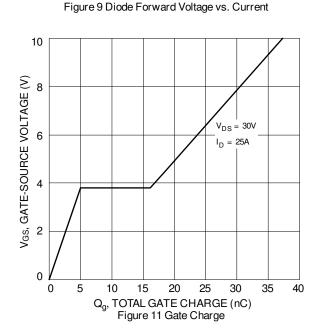
Figure 6 On-Resistance Variation with Temperature











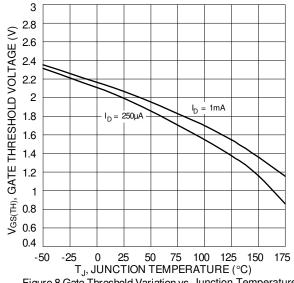
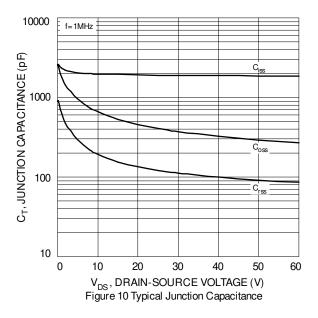
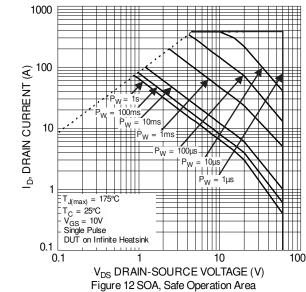
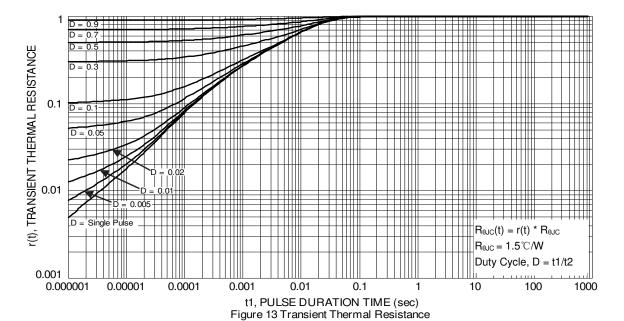


Figure 8 Gate Threshold Variation vs. Junction Temperature









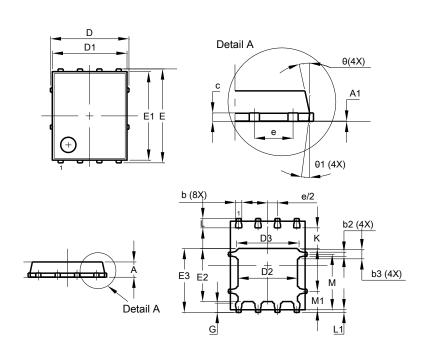


Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

Site 1:

PowerDI5060-8

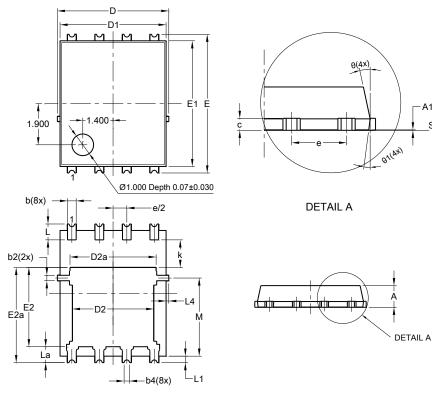


PowerDI5060-8				
Dim	Min	Max	Тур	
Α	0.90	1.10	1.00	
A1	0.00	0.05	-	
b	0.33	0.51	0.41	
b2	0.200	0.350	0.273	
b3	0.40	0.80	0.60	
C	0.230	0.330	0.277	
D		5.15 BSC		
D1	4.70	5.10	4.90	
D2	3.70	4.10	3.90	
D3	3.90	4.30	4.10	
Е	(6.15 BSC		
E1	5.60	6.00	5.80	
E2	3.28	3.68	3.48	
E3	3.99	4.39	4.19	
е		1.27 BSC	;	
G	0.51	0.71	0.61	
K	0.51	-	_	
L	0.51	0.71	0.61	
L1	0.100	0.200	0.175	
M	3.235	4.035	3.635	
M1	1.00	1.40	1.21	
Θ	10°	12°	11°	
Θ1	6°	8°	7°	
All Dimensions in mm				

Site 2:

PowerDI5060-8/SWP (Type UX)

Seating Plane



PowerDI5060-8/SWP				
(Type UX)				
Dim	Min	Max	Тур	
Α	0.90	1.10	1.00	
A 1	0	0.05		
b	0.30	0.50	0.41	
b2	0.20	0.35	0.25	
b4	C).25REF	-	
С	0.230	0.330	0.277	
D	5	.15 BS()	
D1	4.70	5.10	4.90	
D2	3.56	3.96	3.76	
D2a	3.78	4.18	3.98	
E		.40 BS0		
E1	5.60	6.00	5.80	
E2	3.46	3.86	3.66	
E2a	4.195	4.595	4.395	
е		.27BSC)	
k	1.05			
L	0.635	0.835	0.735	
La	0.635	0.835	0.735	
L1	0.200	0.400	0.300	
L1a	0.050REF			
L4	0.025	0.225	0.125	
М	3.205	4.005	3.605	
θ	10°	12°	11°	
θ1	6°	8°	7°	
All Dimensions in mm				

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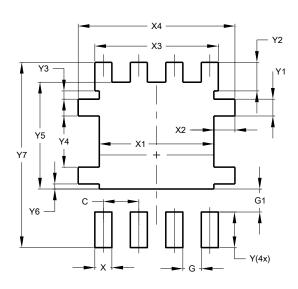


Suggested Pad Layout

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Site 1:

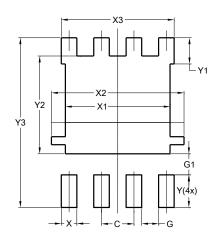
PowerDI5060-8



Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
X	0.610
X1	4.100
X2	0.755
Х3	4.420
X4	5.610
Υ	1.270
Y1	0.600
Y2	1.020
Y3	0.295
Y4	1.825
Y5	3.810
Y6	0.180
Y 7	6.610
-	

Site 2:

PowerDI5060-8/SWP (Type UX)



Dimensions	Value (in mm)		
С	1.270		
G	0.660		
G1	0.820		
Х	0.610		
X1	4.100		
X2	5.190		
Х3	4.420		
Υ	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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